

## Electronic Filing System (EFS) Data Electronic Patent Application Submission USPTO Use Only

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Application ID:

10706468

Title of Invention:

SEMICONDUCTOR PACKAGE WITH CHAMFERED CORNERS

AND METHOD OF

MANUFACTURING THE SAME

First Named Inventor:

**Sung Yang** 

Domestic/Foreign Application:

**Domestic Application** 

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Statement

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6744

Attorney Docket Number:

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∕Electronic Version v1.1
Stylesheet Version v1.1.0

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First Named Applicant:

Sung Jin Yang

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Submitted by:	Elec. Sign.	Sign. Capacity
Mark B. Garred Registered Number: 34,823	/mbg/	Attorney

Documents being submitted

Files

us-ids

ids6-usidst.xml

us-ids.dtd

us-ids.xsl

Comments



### **ELECTRONIC INFORMATION DISCLOSURE STATEMENT**

Electronic Version v18 Stylesheet Version v18.0

> Title of Invention

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Art Unit:

2811

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or 6545345 or 6559525 or 6566168 ).pn.

#### **US Patent Documents**

Note: Applicant is not required to submit a paper copy of cited US Patent Documents

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## Signature

Examiner Name	Date